

SGM2081 500mA, High PSRR, Low Dropout Linear Regulator with Programmable Soft-Start

GENERAL DESCRIPTION

The SGM2081 is a high PSRR and low dropout linear regulator with programmable soft-start. It is capable of supplying 500mA output current with typical $V_{\rm IN}$ dropout voltage of only 30mV. The operating input voltage range is from 0.8V to 5.5V and bias supply voltage range is from 2.7V to 5.5V. The output voltage range is from 0.8V to 3.6V.

Other features include an open-drain power-good (PG) output, logic-controlled shutdown mode, short-circuit current limit and thermal shutdown protection. The SGM2081 has automatic discharge function to quickly discharge V_{OUT} in the disabled status.

The SGM2081 is available in a Green TDFN-3×3-10AL package. It operates over an operating temperature range of -40°C to +125°C.

FEATURES

- Input Supply Voltage Range: 0.8V to 5.5V
- Bias Supply Voltage Range: 2.7V to 5.5V
- Adjustable Output from 0.8V to 3.6V
- Output Voltage Accuracy: ±1% at +25℃
- 500mA Output Current
- Quiescent Current: 0.9mA (TYP)
- V_{IN} Dropout Voltage: 30mV (TYP) at 500mA
- V_{BIAS} Dropout Voltage: 1000mV (TYP) at 500mA
- Low Noise: 29μV_{RMS} (TYP)
- Shutdown Ground Current: 0.1µA (TYP)
- Current Limiting and Thermal Protection
- Programmable Soft-Start Output
- Support Power-Good Indicator Function
- With Output Automatic Discharge
- Stable with Small Case Size Ceramic Capacitors
- -40°C to +125°C Operating Temperature Range
- Available in a Green TDFN-3×3-10AL Package

APPLICATIONS

Servers

Power for Processors

Power Modules

Consumer Electronics

Programmable Soft-Start Applications

TYPICAL APPLICATION

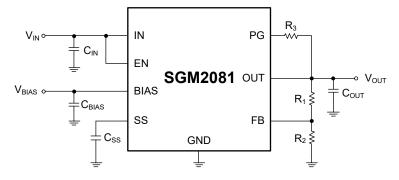


Figure 1. Typical Application Circuit

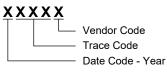


PACKAGE/ORDERING INFORMATION

MODEL	PACKAGE DESCRIPTION	SPECIFIED TEMPERATURE RANGE	EMPERATURE ORDERING NUMBER		PACKING OPTION
SGM2081	TDFN-3×3-10AL	-40°C to +125°C	SGM2081XTGZ10G/TR	SGM 2081GZ XXXXX	Tape and Reel, 4000

MARKING INFORMATION

NOTE: XXXXX = Date Code, Trace Code and Vendor Code.



Green (RoHS & HSF): SG Micro Corp defines "Green" to mean Pb-Free (RoHS compatible) and free of halogen substances. If you have additional comments or questions, please contact your SGMICRO representative directly.

ABSOLUTE MAXIMUM RATINGS

IN, BIAS, PG, EN to GND	0.3V to 6V
OUT to GND	0.3V to (V _{IN} + 0.3V)
SS, FB to GND	0.3V to 6V
PG Sink Current, I _{PG}	0mA to 1.5mA
Package Thermal Resistance	
TDFN-3×3-10AL, θ _{JA}	43.9°C/W
TDFN-3×3-10AL, θ _{JB}	17.1°C/W
TDFN-3×3-10AL, $\theta_{JC(TOP)}$	46.7°C/W
TDFN-3×3-10AL, $\theta_{\text{JC(BOT)}}$	5.1°C/W
Junction Temperature	+150°C
Storage Temperature Range	65°C to +150°C
Lead Temperature (Soldering, 10s)	+260°C
ESD Susceptibility	
HBM	8000V
CDM	1000V

RECOMMENDED OPERATING CONDITIONS

Input Supply Voltage Range	0.8V to 5.5V
BIAS Supply Voltage Range	2.7V to 5.5V
Enable Input Voltage Range	0V to 5.5V
Input Effective Capacitance, C _{IN}	1µF (MIN)
BIAS Effective Capacitance, C_{BIAS}	0.1µF (MIN)
Output Effective Capacitance, C_{OUT}	1μF to 1000μF
Operating Junction Temperature Range	40°C to +125°C

OVERSTRESS CAUTION

Stresses beyond those listed in Absolute Maximum Ratings may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect reliability. Functional operation of the device at any conditions beyond those indicated in the Recommended Operating Conditions section is not implied.

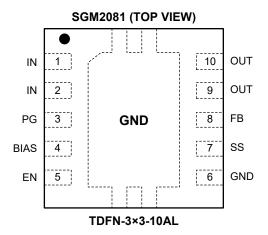
ESD SENSITIVITY CAUTION

This integrated circuit can be damaged if ESD protections are not considered carefully. SGMICRO recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage. ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because even small parametric changes could cause the device not to meet the published specifications.

DISCLAIMER

SG Micro Corp reserves the right to make any change in circuit design, or specifications without prior notice.

PIN CONFIGURATION



PIN DESCRIPTION

PIN	NAME	FUNCTION
1, 2	IN	Input Supply Voltage Pin. It is recommended to use a 2.2µF or larger ceramic capacitor from IN pin to ground to get good power supply decoupling. This ceramic capacitor should be placed as close as possible to IN pin.
3	PG	Open-Drain Power-Good Output Pin. An open-drain output and active high when the output voltage reaches the target voltage.
4	BIAS	Bias Voltage Supply Pin for Internal Control Circuits. It is recommended to use a 0.22µF or larger ceramic capacitor from BIAS pin to ground and this ceramic capacitor should be placed as close as possible to BIAS pin.
5	EN	Enable Pin. Drive EN high to turn on the regulator. Drive EN low to turn off the regulator.
6	GND	Ground
7	SS	Soft-Start Pin. The soft-start time is determined by an external capacitor connected to this pin.
8	FB	Feedback Pin. Connect this pin to the midpoint of an external resistor divider to adjust the output voltage. Place the resistors as close as possible to this pin.
9, 10	OUT	Regulator Output Pin. It is recommended to use a ceramic capacitor with effective capacitance in the range of $1\mu F$ to $1000\mu F$ to ensure stability. This ceramic capacitor should be placed as close as possible to OUT pin.
Exposed Pad	GND	Exposed Pad. Connect it to GND internally. Connect it to a large ground plane to maximize thermal performance. This pad is not an electrical connection point.

FUNCTIONAL BLOCK DIAGRAM

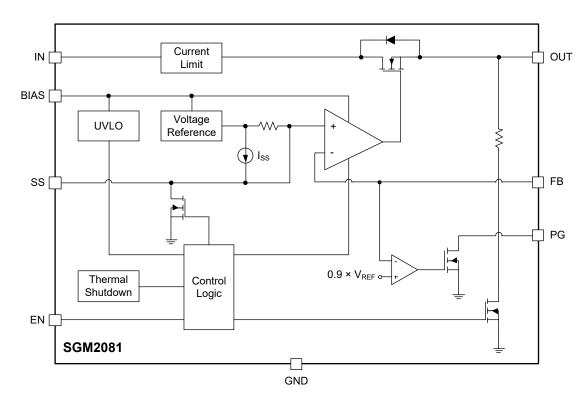


Figure 2. Block Diagram

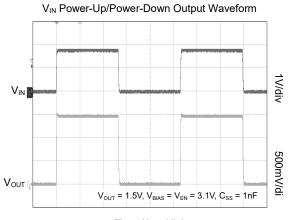
ELECTRICAL CHARACTERISTICS

 $(V_{IN} = V_{OUT(NOM)} + 0.3V, V_{BIAS} = 2.7V \text{ or } (V_{OUT(NOM)} + 1.6V) \text{ whichever is greater, } V_{OUT} = 0.8V, V_{EN} = 1.1V, I_{OUT} = 1mA, C_{IN} = 10\mu\text{F}, C_{BIAS} = 0.22\mu\text{F}, C_{OUT} = 10\mu\text{F}, C_{SS} = 1n\text{F}, T_{J} = -40^{\circ}\text{C} \text{ to } +125^{\circ}\text{C}, \text{ typical values are at } T_{J} = +25^{\circ}\text{C}, \text{ unless otherwise noted.})$

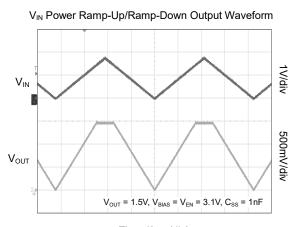
PARAMETER SYMBOL CONDITIONS MIN MAX UNITS Input Supply Voltage Range V_{IN} 8.0 5.5 ٧ Bias Supply Voltage Range V_{BIAS} 2.7 5.5 V V_{BIAS} rising 1.66 2.10 ٧ Under-Voltage Lockout V_{UVLO} Hysteresis 138 mV $V_{OUT} = V_{ADJ}$, $V_{BIAS} = 2.7V$ to 5.5V, T_J = +25°C 0.7920 0.8 0.8080 Feedback Voltage ٧ V_{ADJ} $T_{J} = -40^{\circ}C$ to $+125^{\circ}C$ 0.7880 8.0 0.8096 $I_{OUT} = 1$ mA to 500mA Feedback Pin Current $V_{ADJ} = 0.9V$ 1 I_{ADJ} 30 nΑ IN Pin Current I_{IN} $I_{OUT} = 0mA$ 0.11 0.2 mΑ **BIAS Pin Operating Current** $I_{OUT} = 0mA$ 0.9 1.3 mA I_{BIAS} ΔV_{OUT} V_{IN} Line Regulation $V_{IN} = (V_{OUT(NOM)} + 0.3V)$ to 5.5V 800.0 0.10 %/V $\Delta V_{\text{IN}} \times V_{\text{OUT}}$ ΔV оит V_{BIAS} Line Regulation $V_{BIAS} = 2.7V \text{ or } (V_{OUT(NOM)} + 1.6V) \text{ to } 5.5V$ 0.015 0.10 %/V $\Delta V_{\text{BIAS}} \times V_{\text{OUT}}$ ΛV_{OUT} I_{OUT} = 1mA to 500mA Load Regulation 0.08 0.6 %/A $V_{\text{OUT}} \times \Delta I_{\text{OUT}}$ V_{IN} Dropout Voltage $V_{OUT} = 90\% \times V_{OUT(NOM)}$, $I_{OUT} = 500mA$ 30 മറ m\/ V_{DROP_IN} $V_{OUT} = 90\% \times V_{OUT(NOM)}$, $I_{OUT} = 500$ mA, $V_{IN} = V_{BIAS}$ V_{BIAS} Dropout Voltage V_{DROP_BIAS} 1000 1400 mV **Output Current Limit** $V_{IN} = V_{OUT(NOM)} + 0.6V$, $V_{OUT} = 97\% \times V_{OUT(NOM)}$ 0.65 1.45 2.3 Α I_{LIMIT} Short Current Limit $V_{OUT} = 0V$ 500 mΑ I_{SHORT} T_J = +25°C 0.1 2 Shutdown Ground Current I_{SHDN} $V_{EN} \le 0.4V$ μΑ $T_J = -40^{\circ}C$ to $+125^{\circ}C$ 8 EN input voltage high, $V_{BIAS} = 2.7V$ to 5.5V 1 5.5 ٧ V_{IH} **Enable Threshold Voltage** V_{IL} EN input voltage low, $V_{BIAS} = 2.7V$ to 5.5V 0 0.4 V **Enable Pin Hysteresis** 116 mV V_{EN(HYS)} 27 Enable Pin Deglitch Time $V_{EN(DG)}$ μs **Enable Pin Current** I_{EN} $V_{EN} = 5.5V$ 10 1000 nΑ Ω Output Discharge Resistance R_{DIS} $V_{BIAS} = 2.7V$ 500 770 1200 From assertion of V_{EN} to $V_{OUT} = 90\% \times V_{OUT(NOM)}$ Turn-On Time t_{ON} 230 นร Css = open PG High Threshold PG_{HTH} V_{OUT} increasing 94 98 $%V_{OUT}$ PG Low Threshold V_{OUT} decreasing 86 94 $%V_{OUT}$ PG_{LTH} 90 $\mathsf{PG}_{\mathsf{HYS}}$ PG Trip Hysteresis 5 %V_{out} mV PG Pin Low-Level Output Voltage $V_{PG(LO)}$ $V_{OUT} < V_{IT}$, $I_{SINK} = 1mA$ 200 PG Pin Leakage Current $I_{PG(LKG)}$ $V_{OUT} > V_{IT}$, $V_{PG} = 5.5V$ 10 500 nΑ Soft-Start Charging Current $V_{SS} = 0.4V$ 390 650 nΑ I_{SS} $\overline{V_{IN} \text{ to } V_{OUT}, V_{OUT}} = 1.5 V$ f = 1kHzdB 80 VIN Power Supply Rejection Ratio $V_{IN} = 2V$, $\Delta V_{RIPPLE} = 0.2V_{P-P}$, f = 300kHz42 dB $I_{OUT} = 500 \text{mA}$ **PSRR** V_{BIAS} to V_{OUT} , $V_{OUT} = 1.5V$, f = 1kHzdB 66 V_{BIAS} Power Supply Rejection Ratio $V_{IN} = 2V$, $\Delta V_{RIPPLE} = 0.2V_{P-P}$, f = 300kHz53 dB $I_{OUT} = 500 \text{mA}$ $V_{OUT} = 1.5V$, $I_{OUT} = 500$ mA, $C_{SS} = 1$ nF, Output Noise Voltage 29 μV_{RMS} f = 10Hz to 100kHz Thermal Shutdown Temperature T_{SHDN} 165 °C Thermal Shutdown Hysteresis ΔT_{SHDN} 25

TYPICAL PERFORMANCE CHARACTERISTICS

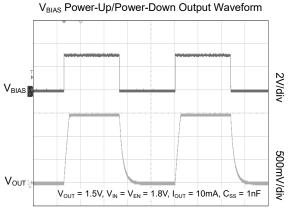
 T_J = +25°C, V_{IN} = V_{OUT} + 0.3V, V_{BIAS} = 2.7V or (V_{OUT} + 1.6V), V_{EN} = V_{BIAS} , I_{OUT} = 1mA, I_{OUT} = 1mF, I_{OUT} = 10 I_{OUT} = 1



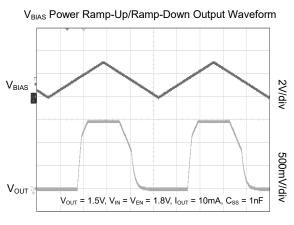
Time (2ms/div)



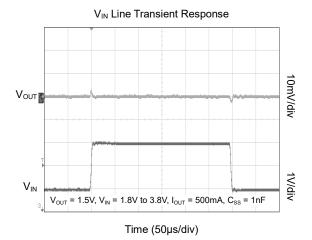
Time (2ms/div)



Time (10ms/div)



Time (10ms/div)

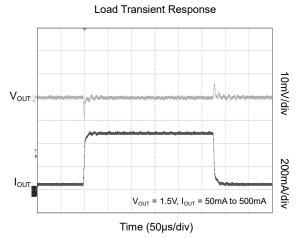


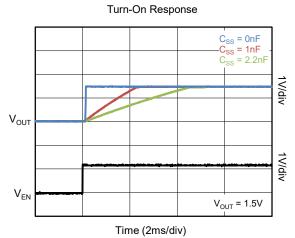
V_{BIAS} Line Transient Response

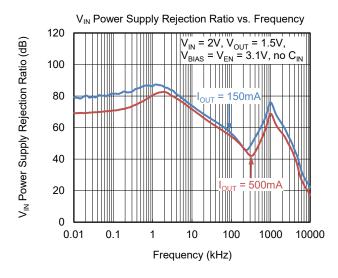
V_{OUT} = 1.5V, V_{BIAS} = 3.1V to 5.1V, I_{OUT} = 500mA, C_{SS} = 1nF

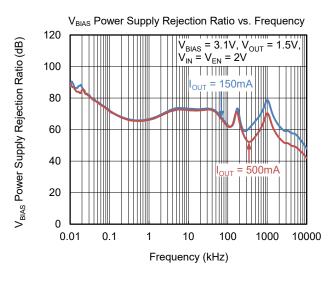
TYPICAL PERFORMANCE CHARACTERISTICS (continued)

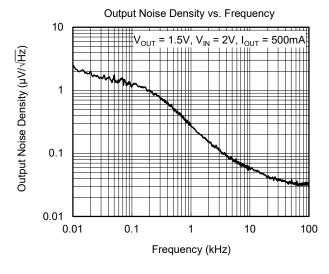
 T_J = +25°C, V_{IN} = V_{OUT} + 0.3V, V_{BIAS} = 2.7V or (V_{OUT} + 1.6V), V_{EN} = V_{BIAS} , I_{OUT} = 1mA, I_{OUT} = 1mF, I_{OUT} = 10 I_{OUT} = 1

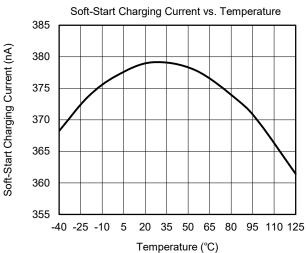






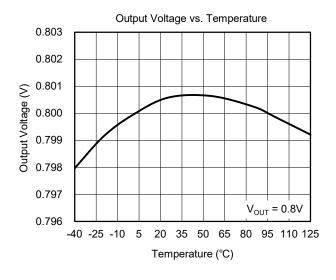


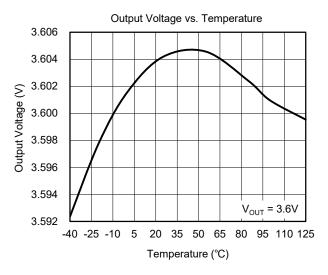


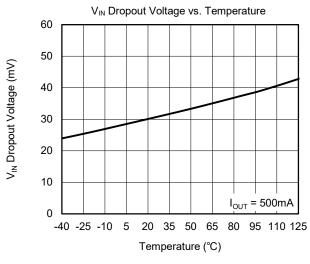


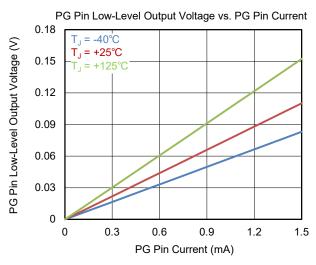
TYPICAL PERFORMANCE CHARACTERISTICS (continued)

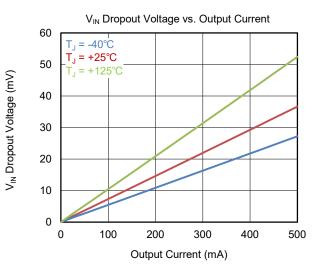
 T_J = +25°C, V_{IN} = V_{OUT} + 0.3V, V_{BIAS} = 2.7V or (V_{OUT} + 1.6V), V_{EN} = V_{BIAS} , I_{OUT} = 1mA, I_{OUT} = 1mF, I_{OUT} = 10 I_{OUT} = 1

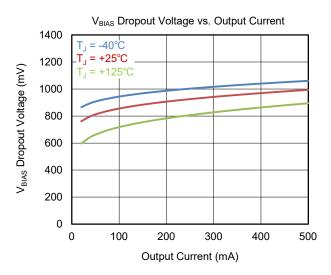






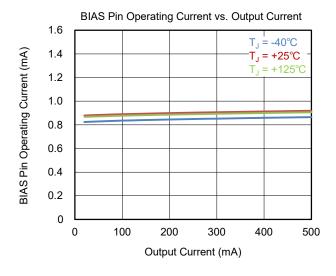


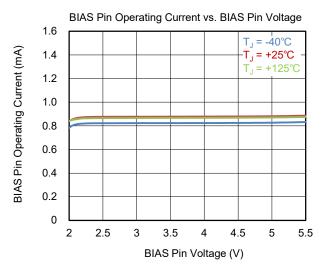


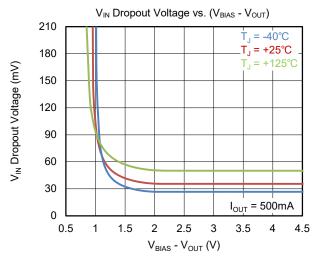


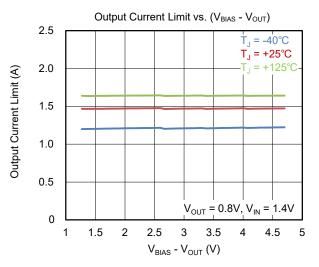
TYPICAL PERFORMANCE CHARACTERISTICS (continued)

 T_J = +25°C, V_{IN} = V_{OUT} + 0.3V, V_{BIAS} = 2.7V or (V_{OUT} + 1.6V), V_{EN} = V_{BIAS} , I_{OUT} = 1mA, I_{OUT} = 1mF, I_{OUT} = 10 I_{OUT} = 1









APPLICATION INFORMATION

The SGM2081 is a low noise and low dropout LDO and provides 500mA output current. These features make the device a reliable solution to solve many challenging problems in the generation of clean and accurate power supply. The high performance also makes the SGM2081 useful in a variety of applications. The SGM2081 provides protection functions for output overload, output short-circuit condition and overheating.

The SGM2081 provides an EN pin as an external chip enable control to enable/disable the device. When the regulator is in shutdown state, the shutdown ground current consumes as low as 0.1µA (TYP).

Input Capacitors Selection (C_{IN} and C_{BIAS})

The input decoupling capacitors should be placed as close as possible to the IN pin and BIAS pin to ensure the device stability. C_{IN} = 2.2 μ F and C_{BIAS} = 0.22 μ F or larger X7R or X5R ceramic capacitors are selected to get good dynamic performance.

When V_{IN} is required to provide large current instantaneously, a large effective input capacitor is required. Multiple input capacitors can limit the input tracking inductance. Adding more input capacitors is available to restrict the ringing and to keep it below the device absolute maximum ratings. For C_{OUT} with larger capacitance, it is recommended to choose the larger capacitance C_{IN} .

Output Capacitor Selection (Cout)

The output capacitor should be placed as close as possible to the OUT pin. $10\mu F$ or larger X7R or X5R ceramic capacitor is selected to get good dynamic performance. The minimum effective capacitance of C_{OUT} that SGM2081 can remain stable is $1\mu F.$ For ceramic capacitor, temperature, DC bias and package size will change the effective capacitance, so enough margin of C_{OUT} must be considered in design. Additionally, C_{OUT} with larger capacitance and lower ESR will help increase the high frequency PSRR and improve the load transient response.

Soft-Start Capacitor Selection (C_{SS})

The SGM2081 is designed for a monotonic soft-start time of output rising, it can be achieved via an external capacitor (C_{SS}) on the SS pin. Using an external C_{SS} is recommended for general application. It is not only for the in-rush current minimization but also helps reduce the noise component from internal reference.

Dropout Voltage

The SGM2081 specifies two dropout voltages because there are two power supplies V_{IN} and V_{BIAS} and one V_{OUT} regulator output. When the output voltage is lower than 1.6V, V_{BIAS} dropout voltage does is not applicable because the minimum bias operating voltage is 2.7V.

When V_{OUT} begins to decrease and V_{BIAS} is high enough, the V_{IN} dropout voltage equals to V_{IN} - V_{OUT} . V_{BIAS} dropout voltage refers to V_{BIAS} - V_{OUT} when the IN and BIAS pins are connected together and V_{OUT} begins to decrease.

Adjustable Regulator

The output voltage of the SGM2081 can be adjusted from 0.8V to 3.6V. The FB pin will be connected to two external resistors as shown in Figure 3. The output voltage is determined by the following equation:

$$V_{OUT} = V_{ADJ} \times \left(1 + \frac{R_1}{R_2}\right) \tag{1}$$

where:

 V_{OUT} is output voltage and V_{ADJ} is the internal voltage reference, V_{ADJ} = 0.8V. Choose R_2 = 10k Ω to maintain an 80 μ A minimum load.

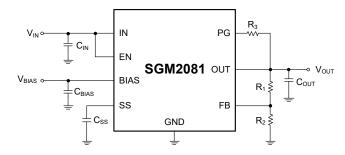


Figure 3. Adjustable Output Voltage Application

APPLICATION INFORMATION (continued)

Enable Operation

The SGM2081 uses the EN pin to enable/disable the device and to deactivate/activate the output automatic discharge function.

When the EN pin voltage is lower than 0.4V, the device is in shutdown state. There is no current flowing from IN to OUT pins. In this state, the automatic discharge transistor is active to discharge the output voltage through a 770Ω (TYP) resistor and the PG output is pulled down.

When the EN pin voltage is higher than 1.0V, the device is in active state. The output voltage is regulated to the expected value and the automatic discharge transistor is turned off.

Under-Voltage Lockout (UVLO)

The UVLO circuit monitors the input voltage to prevent the device from turning on before V_{BIAS} rises above the V_{UVLO} threshold. The UVLO circuit responds quickly to glitches on the IN pin and attempts to disable the output of the device if any of these rails collapses. The local input capacitance prevents severe brownouts in most applications. When the SGM2081 enters UVLO, the PG output is pulled down.

Power-Good Function

The SGM2081 features PG function for monitoring the feedback voltage, so as to reflect the state of the output voltage. When the output voltage is lower than PGITH. the PG pin open-drain engages and pulls the PG pin close to GND. When the output voltage is higher than PG_{HTH}, the PG pin is indicated as high impedance. Connecting the PG pin to an external power supply via a pull-up resistor enables any downstream device to receive a power-good valid logic signal for sequencing. The resistance range of the pull-up resistor is recommended to be between $10k\Omega$ and $100k\Omega$.

The PG output is pulled down when the SGM2081 is in one of the following states, including disabled, thermal shutdown, or UVLO.

Reverse Current Protection

The pass transistor has an inherent body diode which will be forward biased in the case when $V_{OUT} > (V_{IN} +$ 0.3V). If extended reverse voltage operation is anticipated, external limiting might be appropriate.

Negatively Biased Output

When the output voltage is negative, the chip may not start up due to parasitic effects. Ensure that the output is greater than -0.3V under all conditions. If negatively biased output is excessive and expected in the application, a Schottky diode can be added between the OUT pin and GND pin.

Output Current Limit and Short-Circuit Protection

When overload events happen, the output current is internally limited to 1.45A (TYP). When the OUT pin is shorted to ground, the short-circuit protection will limit the output current to 500mA (TYP).

Thermal Shutdown

When the die temperature exceeds the threshold value of thermal shutdown, the SGM2081 will be in shutdown state and it will remain in this state until the die temperature decreases to +140°C. When the device enters thermal shutdown, the PG output is pulled low.

Power Dissipation (P_D)

Power dissipation (PD) of the SGM2081 can be calculated by the equation $P_D = (V_{IN} - V_{OUT}) \times I_{OUT}$. The maximum allowable power dissipation (P_{D(MAX)}) of the SGM2081 is affected by many factors, including the difference between junction temperature and ambient temperature (T_{J(MAX)} - T_A), package thermal resistance from the junction to the ambient environment (θ_{JA}), the rate of ambient airflow and PCB layout. P_{D(MAX)} can be approximated by the following equation:

$$P_{D(MAX)} = (T_{J(MAX)} - T_A)/\theta_{JA}$$
 (2)

REVISION HISTORY

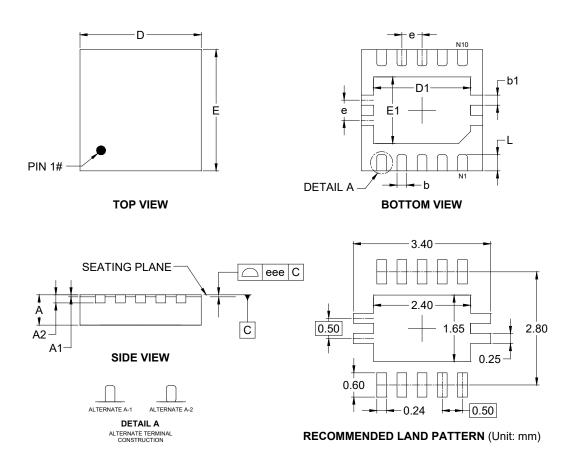
NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

Changes from Original (MAY 2024) to REV.A

Page



PACKAGE OUTLINE DIMENSIONS TDFN-3×3-10AL



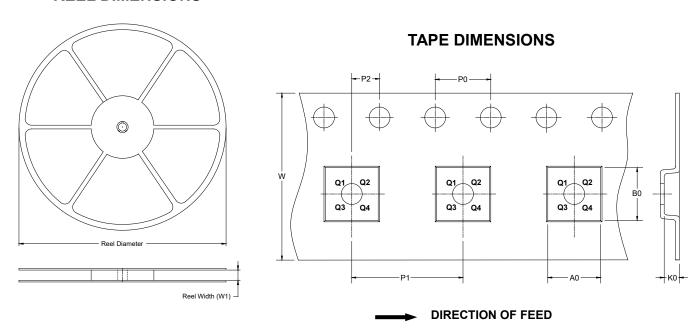
Cymphol	Dimensions In Millimeters						
Symbol	MIN	MOD	MAX				
Α	0.700	-	0.800				
A1	0.000	-	0.050				
A2		0.203 REF					
b	0.180	-	0.300				
b1	0.250 REF						
D	2.900	3.100					
E	2.900	-	3.100				
D1	2.300	-	2.500				
E1	1.550 -		1.750				
е	0.500 BSC						
L	0.300	-	0.500				
eee	0.080						

NOTE: This drawing is subject to change without notice.



TAPE AND REEL INFORMATION

REEL DIMENSIONS

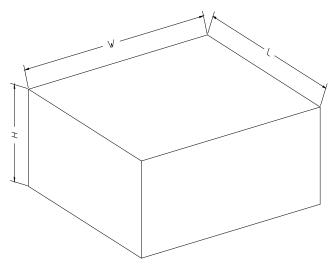


NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF TAPE AND REEL

Package Type	Reel Diameter	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
TDFN-3×3-10AL	13"	12.4	3.30	3.30	1.10	4.0	8.0	2.0	12.0	Q2

CARTON BOX DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF CARTON BOX

Reel Type		Length (mm)	Width (mm)	Height (mm)	Pizza/Carton	
	13"	386	280	370	5	200002